Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
ш	30	fuller in, and substrate.ti.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/01/04 13:39
L2	14	("4612083" "5229550" "5706178" "5902118" "5956843" "6026564" "6054761" "6199273" "6204456" "6208525" "6388204" "6459047" "6479093" "6630630").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 13:46
:13	13	("4612083" "5229550" "5706178" "5902118" "5956843" "6026564" "6054761" "6199273" "6204456" "6208525" "6388204" "6459047" "6479093").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 13:48
L5	5259	(print\$3 wiring circuit circuitiz\$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct\$3 metal\$3) with (filling fill filled dispens\$3 deposit\$3) and (laminat\$3 bonding bond)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 15:45
L6	452	"29"/\$.ccls. and "174"/\$ and 5	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 14:27
L7	372	6 and (first second) with (board substrate wafer)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 14:28

L8	41	("20020050402" "4876120" "5218030" "5258325" "5346747" "5352745" "5426522" "5477612" "5517751" "5640761" "5677045" "5819403" "5821457" "5822850" "5824950" "5830542" "5950306" "6078102" "6092280" "6108903" "6114005" "6154940" "6163957" "6243946" "6374242" "6323436" "6352782" "6355504" "6373717" "6465742" "6580031" "6581280" "6673190" "6708404" "6742031" "6745464" "6748652" "6764748" "6774316").PN.	US-PGPUB; USPAT; USOCR	OR .	ON	2006/01/04 15:32
L9	5	("4302501" "4383363" "4967314" "5346750" "5652042").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 15:34
L10	222	(first second additional multiple) with (print\$3 wiring circuit circuitiz\$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct\$3 metal\$3) with (filling fill filled dispens\$3 deposit\$3) and (laminat\$3 bonding bond) and partial\$2 with (filling fill filled dispens\$3 deposit\$3)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 15:48
111	240	(first second additional multiple) with (print\$3 wiring circuit circuitiz\$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct\$3 metal\$3) with (filling fill filled dispens\$3 deposit\$3) and (laminat\$3 bonding bond) and (partly partial\$2) with (filling fill filled dispens\$3 deposit\$3)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 16:33

	1	<u> </u>			г		
L12	44		"4176602"	US-PGPUB;	OR	ON	2006/01/04 15:56
			"4619715"	USPAT;			
		"478 94 11"	"4859268"	USOCR			
		"5062896"	"50 644 82"		İ		
		"5088189"	"5128746"				
		"5150195" i	"5156771" İ				
		"520 4 025" i	•				
		"5334261"					
		"5360672"	•				
		"5382300"	•				
		"5405044"	•			[
		"5429785"	•		İ		
		"5450290"					
		"5628926"	•				
		"5641996"					
		"5714803"	•				
1		"5762259"					
		"5822856" I	•				
		"5844320"					
<u> </u>		"5921462"					
			"6054761"				
			"6165885").PN.				
	::::::::::::::::::::::::::::::::::::::					<u>.</u>	
L13	68		"3214827"	US-PGPUB;	OR	ON	2006/01/04 16:00
		* * * * * * * * * * * * * * * * * * *	*3316619*	USPAT;			
		"3509270"	· · · · · · · · · · · · · · · · · · ·	USOCR			
		"3546775"					
		"3606677"					
		"3739469"	·········				
		"3795037"					
		"3829601"					
		"3859711"					
		"4024629"					
		"4216350"	· · · · · · · · · · · · · · · · ·				
		"4249032"	******************				
		"4394712"					
			"4479991"				
		1 1 . 1 1 . 1 . 1 1 . 1 1 . 1 1 . 1 . 1	"4641425"				
		L : . : . : . : . : . : . : . : . : . :	"4677254"				
			"4720470"				
		• · · · · · · · · · · · · · · · · · · ·	"4740414"				
			"4788766"				
			"4817280"				
			"4915795"				
		L	"4954878"				
		"4970106"	· · · · · · · · · · · · · · · · · · ·				
		r:::::::::::::::::::::::::::::::::::::	"5048178"				
		"5056216"					
			"5089880"				
			"5128831"				
			"5140745"				
		"5147210"	"5282312").PN.				

L14	41	("3077511" "3214827" "3316618" "3509270" "3541222" "3546775" "3606677" "3616532" "3739469" "3775844" "3795037" "3795047" "3829601" "3859711" "3862790" "4024629" "4211603" "4216350" "4249302" "4383363" "4642889" "4712161"	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 16:06
		"4729809" "4788766" "4793814" "4935584" "4954878" "5046238" "5069628" "5072075" "5089880" "5129142" "5140745").PN.				
L15	106	(print\$3 wiring circuit circuitiz\$3) near4 (board substrate wafer) with (hole opening cavity via window aperture) and (hole opening cavity via window aperture) with (conduct\$3 metal\$3) with (filling fill filled dispens\$3 deposit\$3) and (laminat\$3 bonding bond) same (partly partial\$2) near3 (filling fill filled dispens\$3 deposit\$3)	USPAT; USOCR; EPO; JPO	OR	ON	2006/01/04 16:34
L16	26	("3148310").URPN.	USPAT	OR	ON	2006/01/04 16:39
L17	54	("3077511" "3214827" "3316618" "3316619" "3509270" "3541222" "3546775" "3561110" "3606677" "3616532" "3739469" "3775844" "3795037" "3795047" "3829601" "3859711" "3862790" "4024629" "4211603" "4216350" "4249032" "4249302" "4383363" "4394712" "4452847" "4479991" "4511757" "4642889" "4712161" "4729809" "4740411" "4755911" "4788766" "4793814" "4935584" "4954878" "4970106" "5089880" "5121299" "5128831" "5129142" "5140745" "5224265" "5232598").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 16:41

L18	13	("3676566" "3934334" "3984244" "4368503" "4394712" "4670770" "4803450" "4830264" "4845311" "4854038" "4864722" "4868350" "4908933").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 16:43
L19	43	("4803450").URPN.	USPAT	OR	ON	2006/01/04 16:44
L20	62	("5129142").URPN.	USPAT	OR	ON	2006/01/04 16:47
121	13	("3676566" "3934334" "3984244" "4368503" "4394712" "4670770" "4803450" "4830264" "4845311" "4854038" "4864722" "4868350" "4908933").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 17:19
L22	1	"5280414".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2006/01/04 18:07
123	6	("4612083" "5902118" "5956843" "6388204" "6459047" "6479093").PN:	US-PGPUB; USPAT; USOER	OR	ON	2006/01/04 18:07